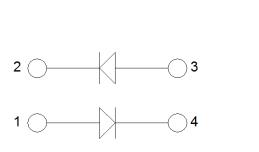


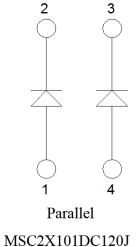
MSC2X101_100DC120J SiC Diode Power Module

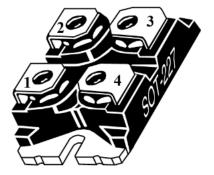
1 Product Overview

This section provides the product overview for the MSC2X101_100DC120J device.



Anti-Parallel MSC2X100DC120J





All ratings at T_j = 25 °C, unless otherwise specified.

Caution: These devices are sensitive to electrostatic discharge. Proper handling procedures should be followed.



1.1 Features

The following are key features of the MSC2X101_100DC120J device:

- Silicon carbide (SiC) Schottky diode
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature-independent switching behavior
 - Positive temperature coefficient on VF
- Very low stray inductance

1.2 Benefits

The following are benefits of the MSC2X101_100DC120J device:

- Outstanding performance at high-frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction-to-case thermal resistance
- RoHS compliant

1.3 Applications

The MSC2X101_100DC120J device is designed for the following applications:

- Uninterruptible power supply (UPS)
- Induction heating
- Welding equipment
- High-speed rectifiers



2 Electrical Specifications

This section provides the electrical specifications for the MSC2X101_100DC120J device.

2.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings per diode for the MSC2X101_100DC120J device.

Table 1 • Absolute Maximum Ratings

Symbol	Parameter		Maximum Ratings	Unit
VRRM	Repetitive peak reverse voltage		1200	V
IF	DC forward current	Tc = 100 °C	100	А

The following table shows the thermal and package characteristics of the MSC2X101_100DC120J.

Table 2 • Thermal and Package Characteristics

Symbol	Characteristic	Min	Тур	Max	Unit
Visol	RMS isolation voltage, any terminal to case t =1 minute, 50 Hz/60 Hz	2500			V
ТјТѕтб	Storage temperature range	-55		175	°C
Τιορ	Recommended junction temperature under switching conditions	-55		T _{Jmax} —25	
Torque	Terminal and mounting screws			1.1	N.m
Wt	Package weight		29.2		g

2.2 Electrical Performance

The following table shows the electrical characteristics per diode of the MSC2X101_100DC120J.

Table 3 • Electrical Characteristics Per Diode

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
VF	Diode forward voltage	IF = 100 A	T _j = 25 °C		1.5	1.8	V
			T _j = 175 °C		2.1		-
Irm	Reverse leakage current	V _R = 1200 V	T _j = 25 °C		30	400	μΑ
			T _j = 175 °C		500		-
Qc	Total capacitive charge	V _R = 600 V			448		nC
С	Total capacitance	$f = 1 MHz, V_R = 4$	f = 1 MHz, V _R = 400 V		492		pF
		f = 1 MHz, V _R = 8	800 V		364		-
RthJC	Junction-to-case thermal resist	ance				0.304	°C/V



2.3 Performance Curves

This section shows the typical performance curves for the MSC2X101_100DC120J device.

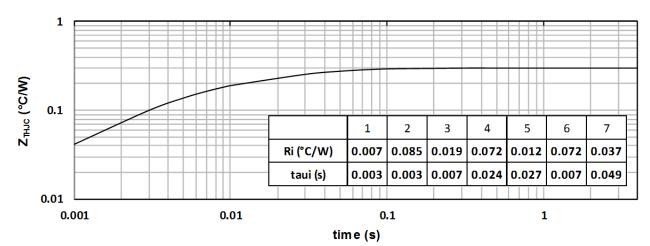


Figure 1 • Maximum Transient Thermal Impedance



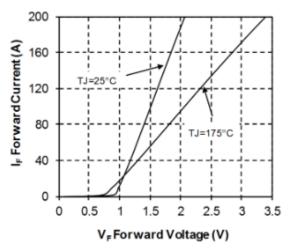
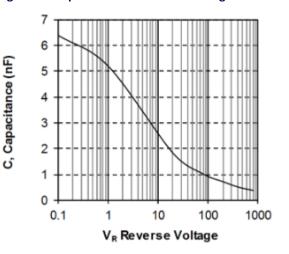


Figure 3 • Capacitance vs. Reverse Voltage





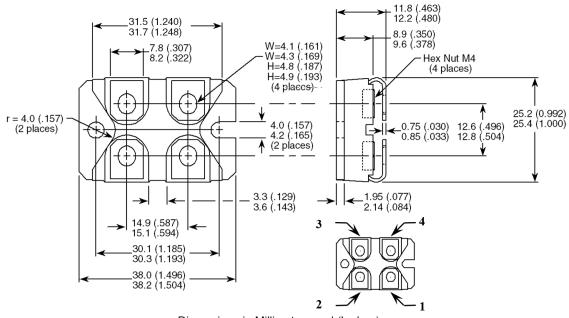
3 Package Specifications

This section shows the package specifications for the MSC2X101_100DC120J device.

3.1 Package Outline Drawing

The following drawing shows the package outline of the MSC2X101_100DC120J device. The dimensions in the following figure are in millimeters.

Figure 4 • Package Outline Drawing



Dimensions in Millimeters and (Inches)





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